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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	-
Total RAM Bits	884736
Number of I/O	528
Number of Gates	1500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FCBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1500-5ffg896c

Architecture

Virtex-II Array Overview

Virtex-II devices are user-programmable gate arrays with various configurable elements. The Virtex-II architecture is optimized for high-density and high-performance logic designs. As shown in [Figure 1](#), the programmable device is comprised of input/output blocks (IOBs) and internal configurable logic blocks (CLBs).

Programmable I/O blocks provide the interface between package pins and the internal configurable logic. Most popular and leading-edge I/O standards are supported by the programmable IOBs.

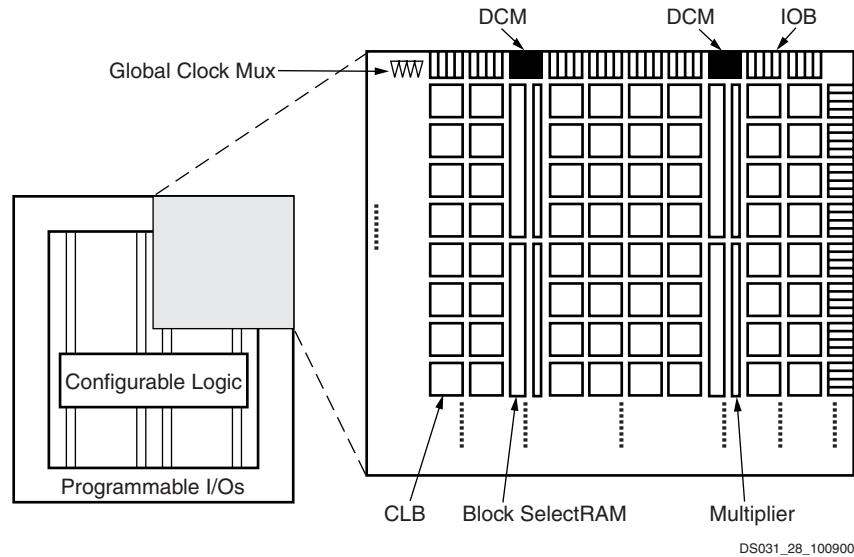


Figure 1: Virtex-II Architecture Overview

The internal configurable logic includes four major elements organized in a regular array.

- Configurable Logic Blocks (CLBs) provide functional elements for combinatorial and synchronous logic, including basic storage elements. BUFTs (3-state buffers) associated with each CLB element drive dedicated segmentable horizontal routing resources.
- Block SelectRAM memory modules provide large 18 Kbit storage elements of dual-port RAM.
- Multiplier blocks are 18-bit x 18-bit dedicated multipliers.
- DCM (Digital Clock Manager) blocks provide self-calibrating, fully digital solutions for clock distribution delay compensation, clock multiplication and division, coarse- and fine-grained clock phase shifting.

A new generation of programmable routing resources called Active Interconnect Technology interconnects all of these elements. The general routing matrix (GRM) is an array of routing switches. Each programmable element is tied to a switch matrix, allowing multiple connections to the general routing matrix. The overall programmable interconnection is hierarchical and designed to support high-speed designs.

All programmable elements, including the routing resources, are controlled by values stored in static memory cells. These values are loaded in the memory cells during

configuration and can be reloaded to change the functions of the programmable elements.

Virtex-II Features

This section briefly describes Virtex-II features.

Input/Output Blocks (IOBs)

IOBs are programmable and can be categorized as follows:

- Input block with an optional single-data-rate or double-data-rate (DDR) register
- Output block with an optional single-data-rate or DDR register, and an optional 3-state buffer, to be driven directly or through a single or DDR register
- Bidirectional block (any combination of input and output configurations)

These registers are either edge-triggered D-type flip-flops or level-sensitive latches.

IOBs support the following single-ended I/O standards:

- LVTTL, LVCMS (3.3V, 2.5V, 1.8V, and 1.5V)
- PCI-X compatible (133 MHz and 66 MHz) at 3.3V
- PCI compliant (66 MHz and 33 MHz) at 3.3V
- CardBus compliant (33 MHz) at 3.3V
- GTL and GTLP

Routing

DCM Locations/Organization

Virtex-II DCMs are placed on the top and bottom of each block RAM and multiplier column. The number of DCMs depends on the device size, as shown in [Table 24](#).

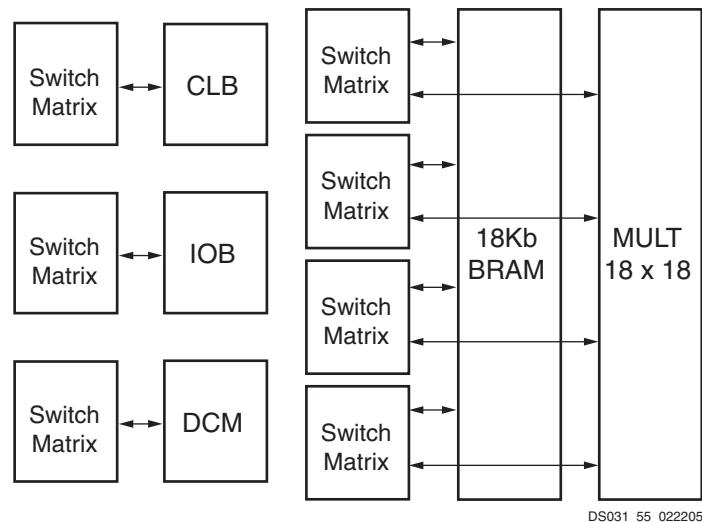
[Table 24: DCM Organization](#)

Device	Columns	DCMs
XC2V40	2	4
XC2V80	2	4
XC2V250	4	8
XC2V500	4	8
XC2V1000	4	8
XC2V1500	4	8
XC2V2000	4	8
XC2V3000	6	12
XC2V4000	6	12
XC2V6000	6	12
XC2V8000	6	12

Active Interconnect Technology

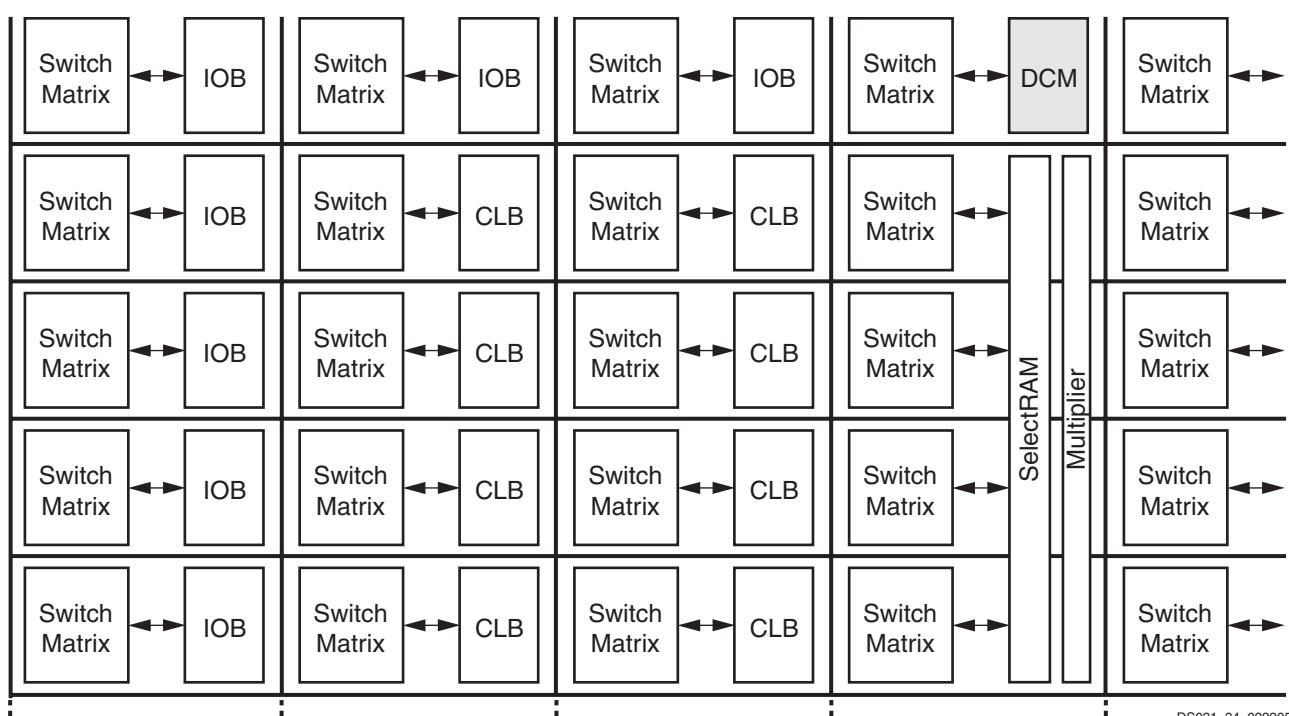
Local and global Virtex-II routing resources are optimized for speed and timing predictability, as well as to facilitate IP cores implementation. Virtex-II Active Interconnect Technology is a fully buffered programmable routing matrix. All rout-

ing resources are segmented to offer the advantages of a hierarchical solution. Virtex-II logic features like CLBs, IOBs, block RAM, multipliers, and DCMs are all connected to an identical switch matrix for access to global routing resources, as shown in [Figure 47](#).



[Figure 47: Active Interconnect Technology](#)

Each Virtex-II device can be represented as an array of switch matrixes with logic blocks attached, as illustrated in [Figure 48](#).



[Figure 48: Routing Resources](#)

Table 12: Register-to-Register Performance (*Continued*)

Description	Device Used & Speed Grade	Register-to-Register Performance	Units
8-bit Adder	XC2V1000 -5	292	MHz
16-bit Adder	XC2V1000 -5	239	MHz
64-bit Adder	XC2V1000 -5	114	MHz
64-bit Counter	XC2V1000 -5	114	MHz
64-bit Accumulator	XC2V1000 -5	110	MHz
Multiplier 18x18 (with Block RAM inputs)	XC2V1000 -5	88	MHz
Multiplier 18x18 (with Register inputs)	XC2V1000 -5	105	MHz
Memory			
Block RAM			
Single-Port 4096 x 4 bits		278	MHz
Single-Port 2048 x 9 bits		277	MHz
Single-Port 1024 x 18 bits		270	MHz
Single-Port 512 x 36 bits		253	MHz
Dual-Port A:4096 x 4 bits & B:1024 x 18 bits		257	MHz
Dual-Port A:1024 x 18 bits & B:1024 x 18 bits		259	MHz
Dual-Port A:2048 x 9 bits & B: 512 x 36 bits		250	MHz
Distributed RAM			
Single-Port 32 x 8-bit	XC2V1000 -5	387	MHz
Single-Port 64 x 8-bit	XC2V1000 -5	335	MHz
Single-Port 128 x 8-bit	XC2V1000 -5	266	MHz
Dual-Port 16 x 8	XC2V1000 -5	409	MHz
Dual-Port 32 x 8	XC2V1000 -5	311	MHz
Dual-Port 64 x 8	XC2V1000 -5	294	MHz
Shift Registers			
128-bit SRL		N/A	MHz
256-bit SRL		N/A	MHz
FIFOs (Async. in Block RAM)			
1024 x 18-bit Read		279	MHz
1024 x 18-bit Write		172	MHz
FIFOs (Sync. in SRL)			
128 x 8-bit		N/A	MHz
128 x 16-bit		N/A	MHz

Pin Definitions

Table 4 provides a description of each pin type listed in Virtex-II pinout tables.

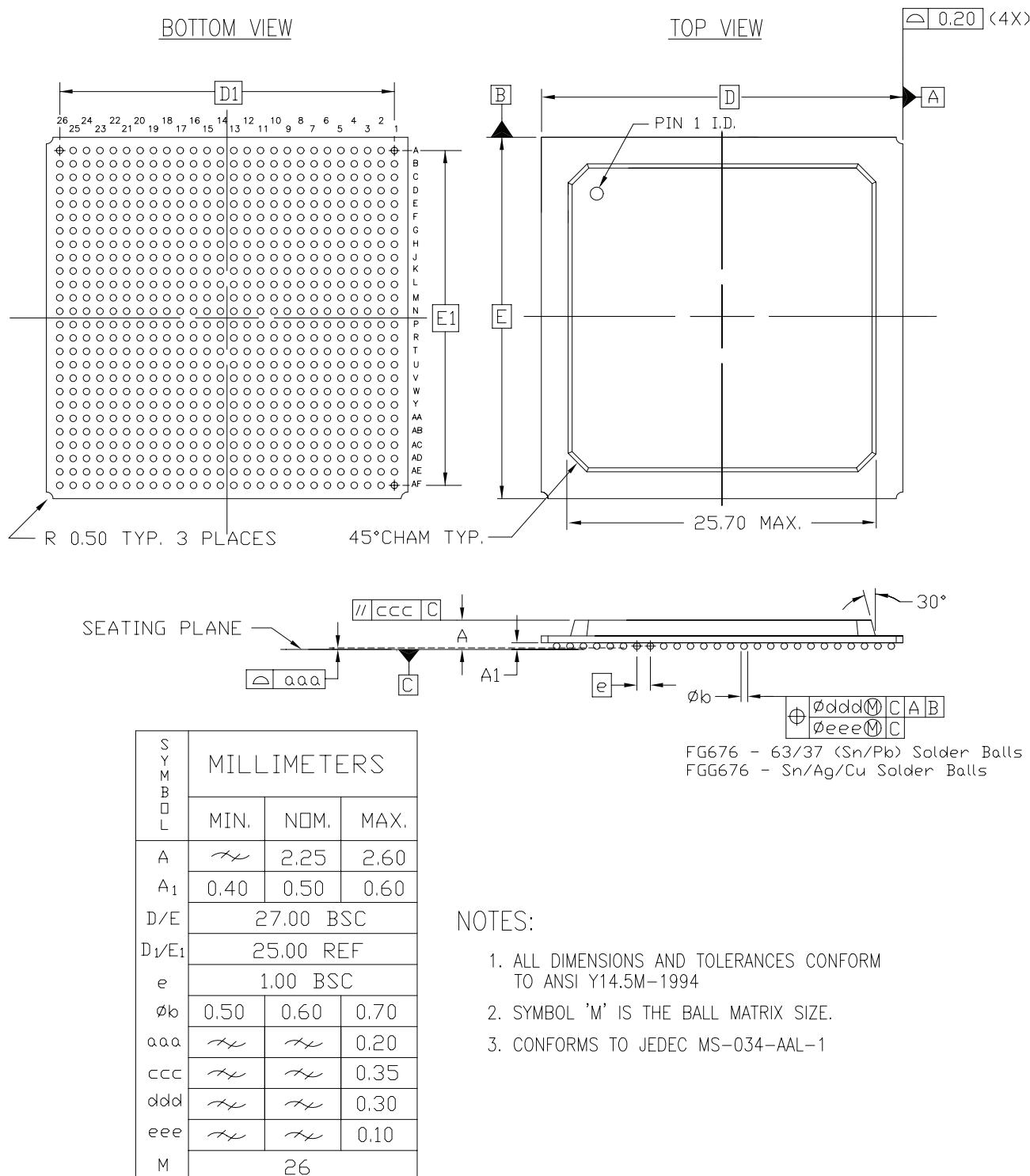
Table 4: Virtex-II Pin Definitions

Pin Name	Direction	Description
User I/O Pins		
IO_LXXY_#	Input/Output/Bidirectional	All user I/O pins are capable of differential signalling and can implement LVDS, ULVDS, BLVDS, LVPECL, or LDT pairs. Each user I/O is labeled “ IO_LXXY_# ”, where: IO indicates a user I/O pin. LXXY indicates a differential pair, with XX a unique pair in the bank and Y = P/N for the positive and negative sides of the differential pair. # indicates the bank number (0 through 7)
Dual-Function Pins		
IO_LXXY_#/ZZZ		The dual-function pins are labelled “ IO_LXXY_#/ZZZ ”, where ZZZ can be one of the following pins: Per Bank - VRP , VRN , or VREF Globally - GCLKx(S/P) , BUSY/DOUT , INIT_B , D0/DIN – D7 , RDWR_B , or CS_B
With /ZZZ:		
D0/DIN, D1, D2, D3, D4, D5, D6, D7	Input/Output	<ul style="list-style-type: none"> In SelectMAP mode, D0 through D7 are configuration data pins. These pins become user I/Os after configuration, unless the SelectMAP port is retained. In bit-serial modes, DIN (D0) is the single-data input. This pin becomes a user I/O after configuration.
CS_B	Input	In SelectMAP mode, this is the active-low Chip Select signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
RDWR_B	Input	In SelectMAP mode, this is the active-low Write Enable signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
BUSY/DOUT	Output	<ul style="list-style-type: none"> In SelectMAP mode, BUSY controls the rate at which configuration data is loaded. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained. In bit-serial modes, DOUT provides preamble and configuration data to downstream devices in a daisy-chain. The pin becomes a user I/O after configuration.
INIT_B	Bidirectional (open-drain)	When Low, this pin indicates that the configuration memory is being cleared. When held Low, the start of configuration is delayed. During configuration, a Low on this output indicates that a configuration data error has occurred. The pin becomes a user I/O after configuration.
GCLKx (S/P)	Input/Output	These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks.
VRP	Input	This pin is for the DCI voltage reference resistor of P transistor (per bank).
VRN	Input	This pin is for the DCI voltage reference resistor of N transistor (per bank).
ALT_VRP	Input	This is the alternative pin for the DCI voltage reference resistor of P transistor.
ALT_VRN	Input	This is the alternative pin for the DCI voltage reference resistor of N transistor.
V _{REF}	Input	These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank).
Dedicated Pins⁽¹⁾		
CCLK	Input/Output	Configuration clock. Output in Master mode or Input in Slave mode.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch)



676–BALL FINE PITCH BGA (FG676/FGG676)

Figure 4: FG676/FGG676 Fine-Pitch BGA Package Specifications

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	GND	Y5		
NA	GND	W19		
NA	GND	W6		
NA	GND	V24		
NA	GND	V18		
NA	GND	V7		
NA	GND	V1		
NA	GND	R21		
NA	GND	R4		
NA	GND	P14		
NA	GND	P13		
NA	GND	P12		
NA	GND	P11		
NA	GND	N14		
NA	GND	N13		
NA	GND	N12		
NA	GND	N11		
NA	GND	M14		
NA	GND	M13		
NA	GND	M12		
NA	GND	M11		
NA	GND	L14		
NA	GND	L13		
NA	GND	L12		
NA	GND	L11		
NA	GND	K21		
NA	GND	K4		
NA	GND	G24		
NA	GND	G18		
NA	GND	G7		
NA	GND	G1		
NA	GND	F19		
NA	GND	F6		
NA	GND	E20		
NA	GND	E5		
NA	GND	D21		

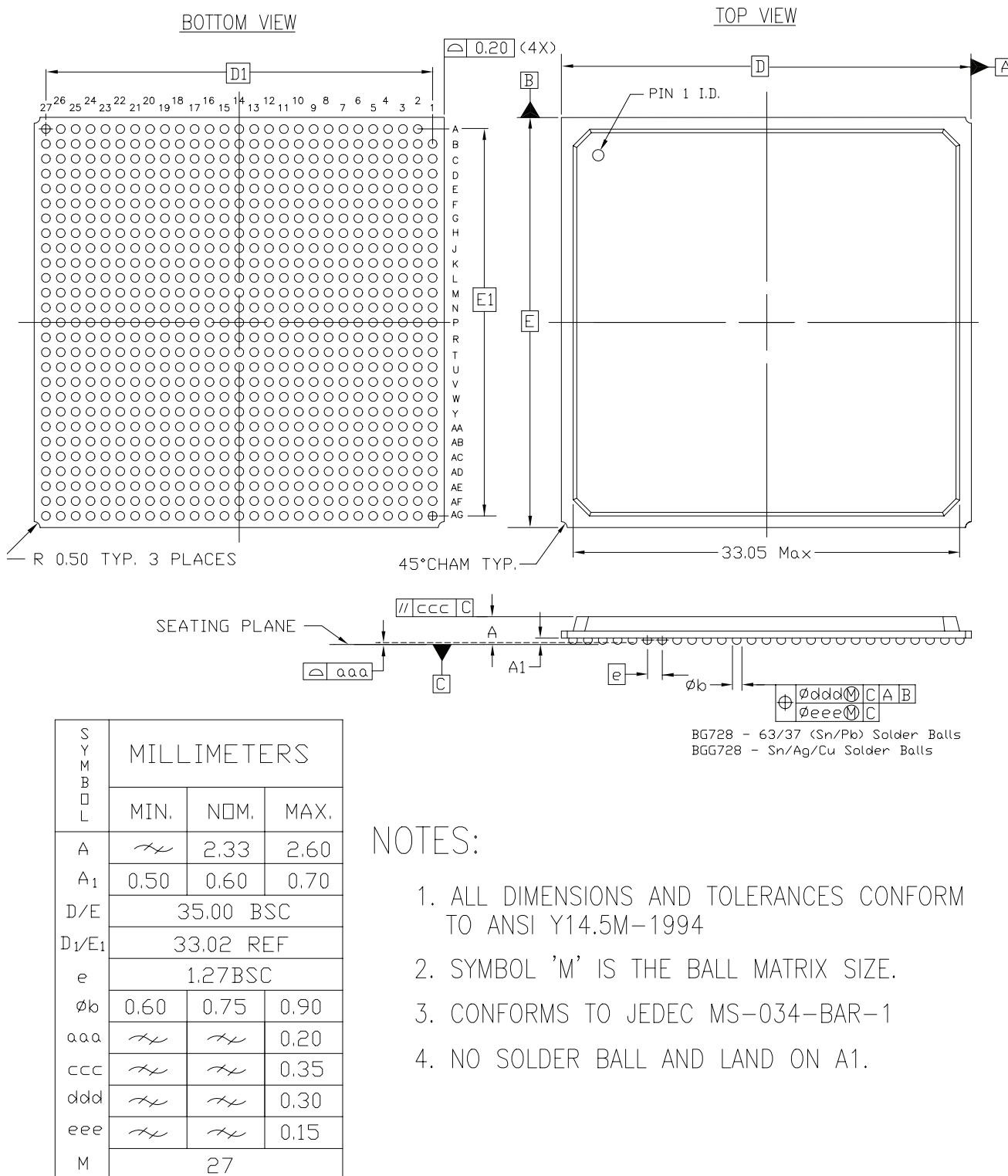
Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
1	IO_L94N_1	C15
1	IO_L94P_1/VREF_1	D15
1	IO_L93N_1	E15
1	IO_L93P_1	F15
1	IO_L92N_1	G15
1	IO_L92P_1	H15
1	IO_L91N_1	J15
1	IO_L91P_1/VREF_1	J16
1	IO_L78N_1	A16
1	IO_L78P_1	B16
1	IO_L76N_1	D16
1	IO_L76P_1	E16
1	IO_L75N_1/VREF_1	F16
1	IO_L75P_1	F17
1	IO_L73N_1	H16
1	IO_L73P_1	H17
1	IO_L72N_1	A17
1	IO_L72P_1	B17
1	IO_L70N_1	C17
1	IO_L70P_1	D17
1	IO_L69N_1/VREF_1	G18
1	IO_L69P_1	G17
1	IO_L67N_1	A18
1	IO_L67P_1	B18
1	IO_L54N_1	C18
1	IO_L54P_1	D18
1	IO_L52N_1	E18
1	IO_L52P_1	F18
1	IO_L51N_1/VREF_1	H19
1	IO_L51P_1	H18
1	IO_L49N_1	A19
1	IO_L49P_1	A20
1	IO_L30N_1	B19
1	IO_L30P_1	C19
1	IO_L28N_1	D19
1	IO_L28P_1	E19

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
3	IO_L72N_3	T20
3	IO_L72P_3	T19
3	IO_L70N_3	U27
3	IO_L70P_3	U26
3	IO_L69N_3/VREF_3	U25
3	IO_L69P_3	V25
3	IO_L67N_3	U21
3	IO_L67P_3	U20
3	IO_L54N_3	V27
3	IO_L54P_3	V26
3	IO_L52N_3	V24
3	IO_L52P_3	V23
3	IO_L51N_3/VREF_3	V22
3	IO_L51P_3	W22
3	IO_L49N_3	V21
3	IO_L49P_3	V20
3	IO_L48N_3	W27
3	IO_L48P_3	Y27
3	IO_L46N_3	W26
3	IO_L46P_3	W25
3	IO_L45N_3/VREF_3	W24
3	IO_L45P_3	W23
3	IO_L43N_3	W21
3	IO_L43P_3	W20
3	IO_L28N_3	W19
3	IO_L28P_3	Y19
3	IO_L27N_3/VREF_3	Y25
3	IO_L27P_3	Y24
3	IO_L25N_3	Y23
3	IO_L25P_3	AA23
3	IO_L24N_3	Y22
3	IO_L24P_3	Y21
3	IO_L22N_3	AA27
3	IO_L22P_3	AB27
3	IO_L21N_3/VREF_3	AA26
3	IO_L21P_3	AA25

BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch)



728-BALL MOLDED BGA (BG728/BGG728)

Figure 6: BG728/BGG728 Standard BGA Package Specifications

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
2	VCCO_2	L10		
2	VCCO_2	L9		
2	VCCO_2	K9		
2	VCCO_2	E2		
3	VCCO_3	AF2		
3	VCCO_3	AA9		
3	VCCO_3	Y10		
3	VCCO_3	Y9		
3	VCCO_3	W10		
3	VCCO_3	W9		
3	VCCO_3	V10		
3	VCCO_3	V9		
3	VCCO_3	V3		
3	VCCO_3	U10		
3	VCCO_3	T10		
4	VCCO_4	AJ5		
4	VCCO_4	AH13		
4	VCCO_4	AB13		
4	VCCO_4	AB12		
4	VCCO_4	AB11		
4	VCCO_4	AB10		
4	VCCO_4	AA15		
4	VCCO_4	AA14		
4	VCCO_4	AA13		
4	VCCO_4	AA12		
4	VCCO_4	AA11		
5	VCCO_5	AJ26		
5	VCCO_5	AH18		
5	VCCO_5	AB21		
5	VCCO_5	AB20		
5	VCCO_5	AB19		
5	VCCO_5	AB18		
5	VCCO_5	AA20		
5	VCCO_5	AA19		
5	VCCO_5	AA18		
5	VCCO_5	AA17		
5	VCCO_5	AA16		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L21N_2	H7	
2	IO_L21P_2/VREF_2	J7	
2	IO_L22N_2	H6	
2	IO_L22P_2	G6	
2	IO_L23N_2	L10	
2	IO_L23P_2	L9	
2	IO_L24N_2	G3	
2	IO_L24P_2	F3	
2	IO_L25N_2	G2	
2	IO_L25P_2	F2	
2	IO_L26N_2	M10	
2	IO_L26P_2	N10	
2	IO_L27N_2	J6	
2	IO_L27P_2/VREF_2	K6	
2	IO_L28N_2	J5	
2	IO_L28P_2	H5	
2	IO_L29N_2	L7	
2	IO_L29P_2	K7	
2	IO_L30N_2	J4	
2	IO_L30P_2	H4	
2	IO_L43N_2	G1	
2	IO_L43P_2	F1	
2	IO_L44N_2	L8	
2	IO_L44P_2	M8	
2	IO_L45N_2	J1	
2	IO_L45P_2/VREF_2	H2	
2	IO_L46N_2	J3	
2	IO_L46P_2	H3	
2	IO_L47N_2	M9	
2	IO_L47P_2	N9	
2	IO_L48N_2	L5	
2	IO_L48P_2	K5	
2	IO_L49N_2	K2	
2	IO_L49P_2	J2	
2	IO_L50N_2	N7	
2	IO_L50P_2	M7	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L51N_2	L6	
2	IO_L51P_2/VREF_2	M6	
2	IO_L52N_2	M3	
2	IO_L52P_2	L3	
2	IO_L53N_2	L4	
2	IO_L53P_2	K4	
2	IO_L54N_2	N4	
2	IO_L54P_2	M4	
2	IO_L67N_2	M2	
2	IO_L67P_2	L2	
2	IO_L68N_2	N8	
2	IO_L68P_2	P8	
2	IO_L69N_2	N6	
2	IO_L69P_2/VREF_2	P6	
2	IO_L70N_2	P5	
2	IO_L70P_2	N5	
2	IO_L71N_2	P10	
2	IO_L71P_2	R10	
2	IO_L72N_2	P3	
2	IO_L72P_2	N3	
2	IO_L73N_2	M1	
2	IO_L73P_2	L1	
2	IO_L74N_2	P9	
2	IO_L74P_2	R9	
2	IO_L75N_2	P2	
2	IO_L75P_2/VREF_2	N2	
2	IO_L76N_2	R4	
2	IO_L76P_2	P4	
2	IO_L77N_2	R8	
2	IO_L77P_2	T8	
2	IO_L78N_2	T3	
2	IO_L78P_2	R3	
2	IO_L79N_2	P1	NC
2	IO_L79P_2	N1	NC
2	IO_L80N_2	T11	NC
2	IO_L80P_2	U11	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L81N_2	R7	NC
2	IO_L81P_2/VREF_2	R6	NC
2	IO_L82N_2	U5	NC
2	IO_L82P_2	T5	NC
2	IO_L83N_2	T10	NC
2	IO_L83P_2	U10	NC
2	IO_L84N_2	U4	NC
2	IO_L84P_2	T4	NC
2	IO_L91N_2	T2	
2	IO_L91P_2	R1	
2	IO_L92N_2	U7	
2	IO_L92P_2	T7	
2	IO_L93N_2	T6	
2	IO_L93P_2/VREF_2	U6	
2	IO_L94N_2	U1	
2	IO_L94P_2	U2	
2	IO_L95N_2	U9	
2	IO_L95P_2	U8	
2	IO_L96N_2	U3	
2	IO_L96P_2	V4	
3	IO_L96N_3	V6	
3	IO_L96P_3	W6	
3	IO_L95N_3	V5	
3	IO_L95P_3	W5	
3	IO_L94N_3	V7	
3	IO_L94P_3	W7	
3	IO_L93N_3/VREF_3	V10	
3	IO_L93P_3	W10	
3	IO_L92N_3	V1	
3	IO_L92P_3	V2	
3	IO_L91N_3	W3	
3	IO_L91P_3	Y3	
3	IO_L84N_3	V9	NC
3	IO_L84P_3	V8	NC
3	IO_L83N_3	W4	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
4	IO_L20N_4	AJ10	
4	IO_L20P_4	AJ9	
4	IO_L21N_4	AH9	
4	IO_L21P_4/VREF_4	AH10	
4	IO_L22N_4	AN5	
4	IO_L22P_4	AN4	
4	IO_L23N_4	AE12	
4	IO_L23P_4	AE13	
4	IO_L24N_4	AM9	
4	IO_L24P_4	AL8	
4	IO_L25N_4	AP5	
4	IO_L25P_4	AP4	
4	IO_L26N_4	AG11	
4	IO_L26P_4	AG12	
4	IO_L27N_4	AN7	
4	IO_L27P_4/VREF_4	AN6	
4	IO_L28N_4	AL10	
4	IO_L28P_4	AL9	
4	IO_L29N_4	AF12	
4	IO_L29P_4	AF13	
4	IO_L30N_4	AK10	
4	IO_L30P_4	AK11	
4	IO_L49N_4	AP7	
4	IO_L49P_4	AP6	
4	IO_L50N_4	AH13	
4	IO_L50P_4	AH12	
4	IO_L51N_4	AJ11	
4	IO_L51P_4/VREF_4	AJ12	
4	IO_L52N_4	AP9	
4	IO_L52P_4	AN8	
4	IO_L53N_4	AG13	
4	IO_L53P_4	AG14	
4	IO_L54N_4	AM11	
4	IO_L54P_4	AL11	
4	IO_L60N_4	AN10	NC
4	IO_L60P_4	AN9	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L71P_6	AD34	
6	IO_L71N_6	AC34	
6	IO_L72P_6	AC31	
6	IO_L72N_6	AD31	
6	IO_L73P_6	Y27	
6	IO_L73N_6	W27	
6	IO_L74P_6	AB29	
6	IO_L74N_6	AA29	
6	IO_L75P_6	AB31	
6	IO_L75N_6/VREF_6	AA31	
6	IO_L76P_6	Y28	
6	IO_L76N_6	Y29	
6	IO_L77P_6	AB33	
6	IO_L77N_6	AA33	
6	IO_L78P_6	AA30	
6	IO_L78N_6	AB30	
6	IO_L79P_6	W24	NC
6	IO_L79N_6	V24	NC
6	IO_L80P_6	AB34	NC
6	IO_L80N_6	AA34	NC
6	IO_L81P_6	W33	NC
6	IO_L81N_6/VREF_6	Y34	NC
6	IO_L82P_6	W25	NC
6	IO_L82N_6	V25	NC
6	IO_L83P_6	Y32	NC
6	IO_L83N_6	AA32	NC
6	IO_L84P_6	W29	NC
6	IO_L84N_6	V29	NC
6	IO_L91P_6	W28	
6	IO_L91N_6	V28	
6	IO_L92P_6	V33	
6	IO_L92N_6	V34	
6	IO_L93P_6	Y31	
6	IO_L93N_6/VREF_6	W31	
6	IO_L94P_6	V26	
6	IO_L94N_6	V27	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	VCCINT	AB17	
NA	VCCINT	AB16	
NA	VCCINT	AB15	
NA	VCCINT	AB14	
NA	VCCINT	AB13	
NA	VCCINT	AA22	
NA	VCCINT	AA13	
NA	VCCINT	Y22	
NA	VCCINT	Y13	
NA	VCCINT	W22	
NA	VCCINT	W13	
NA	VCCINT	V22	
NA	VCCINT	V13	
NA	VCCINT	U22	
NA	VCCINT	U13	
NA	VCCINT	T22	
NA	VCCINT	T13	
NA	VCCINT	R22	
NA	VCCINT	R13	
NA	VCCINT	P22	
NA	VCCINT	P13	
NA	VCCINT	N22	
NA	VCCINT	N21	
NA	VCCINT	N20	
NA	VCCINT	N19	
NA	VCCINT	N18	
NA	VCCINT	N17	
NA	VCCINT	N16	
NA	VCCINT	N15	
NA	VCCINT	N14	
NA	VCCINT	N13	
NA	VCCINT	M23	
NA	VCCINT	M12	
NA	VCCINT	L24	
NA	VCCINT	L11	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L71N_6	AE39		
6	IO_L72P_6	AD36		
6	IO_L72N_6	AE36		
6	IO_L73P_6	AB29		
6	IO_L73N_6	AA29		
6	IO_L74P_6	AE38		
6	IO_L74N_6	AD38		
6	IO_L75P_6	AC33		
6	IO_L75N_6/VREF_6	AD33		
6	IO_L76P_6	AB30		
6	IO_L76N_6	AA30		
6	IO_L77P_6	AD37		
6	IO_L77N_6	AC37		
6	IO_L78P_6	AB34		
6	IO_L78N_6	AC34		
6	IO_L79P_6	AB31		
6	IO_L79N_6	AA31		
6	IO_L80P_6	AD39		
6	IO_L80N_6	AC39		
6	IO_L81P_6	AB35		
6	IO_L81N_6/VREF_6	AC35		
6	IO_L82P_6	AB32		
6	IO_L82N_6	AA32		
6	IO_L83P_6	AC38		
6	IO_L83N_6	AB38		
6	IO_L84P_6	AA33		
6	IO_L84N_6	AB33		
6	IO_L91P_6	Y28		
6	IO_L91N_6	Y29		
6	IO_L92P_6	AB39		
6	IO_L92N_6	AA39		
6	IO_L93P_6	AA36		
6	IO_L93N_6/VREF_6	AB36		
6	IO_L94P_6	Y31		
6	IO_L94N_6	Y32		
6	IO_L95P_6	AA37		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L53N_7	K30	
7	IO_L52P_7	L28	
7	IO_L52N_7	J28	
7	IO_L51P_7/VREF_7	M24	
7	IO_L51N_7	L24	
7	IO_L50P_7	L29	
7	IO_L50N_7	K29	
7	IO_L49P_7	M25	
7	IO_L49N_7	L25	
7	IO_L48P_7	L26	
7	IO_L48N_7	J26	
7	IO_L47P_7	J31	
7	IO_L47N_7	H31	
7	IO_L46P_7	J29	
7	IO_L46N_7	H29	
7	IO_L45P_7/VREF_7	M22	
7	IO_L45N_7	L22	
7	IO_L44P_7	J30	
7	IO_L44N_7	G30	
7	IO_L43P_7	K27	
7	IO_L43N_7	J27	
7	IO_L27P_7/VREF_7	L23	NC
7	IO_L27N_7	K23	NC
7	IO_L25P_7	G31	NC
7	IO_L25N_7	F31	NC
7	IO_L24P_7	F30	
7	IO_L24N_7	E30	
7	IO_L23P_7	K25	
7	IO_L23N_7	J25	
7	IO_L22P_7	H28	
7	IO_L22N_7	G28	
7	IO_L21P_7/VREF_7	H27	
7	IO_L21N_7	G27	
7	IO_L20P_7	K24	
7	IO_L20N_7	J24	
7	IO_L19P_7	E31	
7	IO_L19N_7	D31	
7	IO_L06P_7	F28	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	GND	D10	
NA	GND	D16	
NA	GND	D22	
NA	GND	D28	
NA	GND	E5	
NA	GND	E27	
NA	GND	F6	
NA	GND	F26	
NA	GND	G7	
NA	GND	G13	
NA	GND	G16	
NA	GND	G19	
NA	GND	G25	
NA	GND	H2	
NA	GND	H8	
NA	GND	H24	
NA	GND	H30	
NA	GND	J9	
NA	GND	J23	
NA	GND	K4	
NA	GND	K16	
NA	GND	K28	
NA	GND	N7	
NA	GND	N25	
NA	GND	P14	
NA	GND	P15	
NA	GND	P16	
NA	GND	P17	
NA	GND	P18	
NA	GND	R14	
NA	GND	R15	
NA	GND	R16	
NA	GND	R17	
NA	GND	R18	
NA	GND	T1	
NA	GND	T4	
NA	GND	T7	
NA	GND	T10	